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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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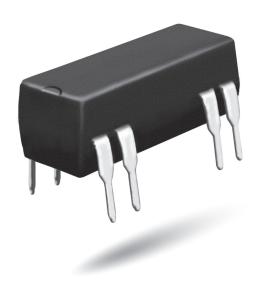
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# **8L SERIES/SPARTAN DIP REED RELAYS**

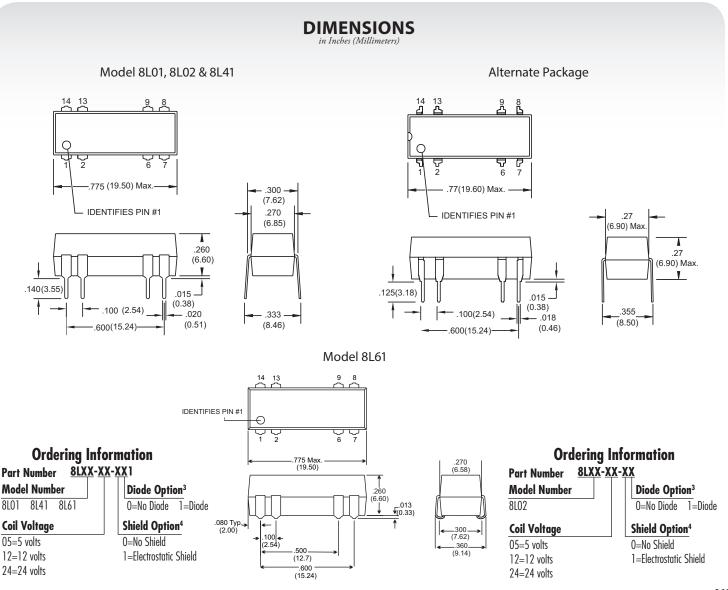


#### **8L Series Economy DIP Reed Relays**

The Coto 8L Spartan Series relays combine Coto quality and economy in the industry standard 14 pin molded DIP package. This series will cross to all competitive DIP packages and is ideal for telecom, security, and other general purpose applications.

## **8L Series Features**

- ▶ Drop-in low cost replacement for industry standard DIP packages
- ► Contact forms; 1A, 2A and 1C available
- Available coils in 5V, 12V and 24V
- ▶ Molded thermoset body on integral lead frame design
- ▶ Hermetically Sealed Contacts
- ▶ Optional Electrostatic Shield and Coil Suppression Diode
- ▶ UL File #E67117 Contact factory for details
- ▶ RoHS compliant



06112015

MODEL NUMBER			8L01 <sup>2,3,4</sup>			8L02 <sup>2,3,4</sup>			8L41 <sup>2,3,4</sup>			8L61 <sup>2,3,4,5</sup>			
Parameters	<b>Test Conditions</b>	Units	1 Form A			2 Form A			1 Form C			1 Form C			
COIL SPECS.															
Nom. Coil Voltage		VDC	5	12	24	5	12	24	5	12	24	5	12	24	
Max. Coil Voltage		VDC	6.5	15	32	6.5	15	32	6.5	15	32	6.5	15	32	
Coil Resistance	+/- 10%, 25° C	Ω	500	500	2150	200	500	2000	200	500	2000	200	500	2000	
Operate Voltage	Must Operate by	VDC - Max.	3.8	9.6	19.2	3.8	9.6	19.2	3.8	9.6	19.2	3.8	9.6	19.2	
Release Voltage	Must Release by	VDC - Min.	0.5	1.0	2.0	0.5	1.0	2.0	0.5	1.0	2.0	0.5	1.0	2.0	
CONTACT RATINGS															
Switching Voltage	Max DC/Peak AC Resist.	Volts		200		200			100				100		
Switching Current	Max DC/Peak AC Resist.	Amps		0.5		0.5			0.25				0.25		
Carry Current	Max DC/Peak AC Resist.	Amps		1.0		1.0			0.5			0.5			
Contact Rating	Max DC/Peak AC Resist.	Watts		10		10			3			3			
Life Expectancy-Typical <sup>1</sup>	Signal Level 1.0V, 10mA	x 10 <sup>6</sup> Ops.		500		500			100			100			
Static Contact Resistance (max. init.)	50mV, 10mA	Ω		0.150	0 0.150			)	0.200			0.200			
Dynamic Contact Resistance (max. init.)	50mV, 50mA at 100 Hz, 1.5 msec	Ω	N/A			N/A			N/A			N/A			
<b>RELAY SPECIFICATIO</b>	NS														
Insulation Resistance (minimum)	Between all Isolated Pins at 100V, 25°C, 40% RH	Ω	10 <sup>10</sup>		10 <sup>10</sup>			10°			10 <sup>9</sup>				
Capacitance - Typical Across Open Contacts	No Shield Shield Floating Shield Guarding	pF pF pF		0.5 1.0 0.5		0.5 0.5 0.2			1.5 1.5 1.0			1.5 1.5 1.0			
Open Contact to Coil	No Shield Shield Floating Shield Guarding	pF pF pF		1.5 2.0 0.5		1.5 2.0 0.5			1.5 2.0 0.5			1.5 2.0 0.5			
Contact to Shield	No Shield Shield Floating Shield Guarding	pF		2.0		1.5			2.0			2.0			
Dielectric Strength (minimum)	Between Contacts Contacts to Shield Contacts/Shield to Coil	VDC/peak AC VDC/peak AC VDC/peak AC		250 1500 1500			250 1500 1500			200 1500 1500			200 1500 1500		
Operate Time - including bounce - Typical	At Nominal Coil Voltage, 30 Hz Square Wave	msec.	0.5			0.5			1.0			1.0			
Release Time - Typical	No Suppression	msec.	0.5			0.5			1.0			1.0			
Top View: Dot stamped on top of relay refers to pin #1 location $Grid = .1"x.1"$ (2.54mm x 2.54mm)				Ī	• 14 • 13 • 9 • 8	1 2 6		<ul><li>14</li><li>13</li><li>9</li><li>8</li></ul>	1 • 2		→ 14 ○ 13	1 • 2		• 14 • 13 • 9 • 8	

#### **Notes:**

- <sup>1</sup> Consult factory for life expectancy at other switching loads.
- <sup>2</sup> Molded depression on top of relay refers to pin #1 location.
- <sup>3</sup> Optional coil suppression diode across pins 2(+) and 6(-).
- <sup>4</sup> Optional ES Shield is tied to pin 9.
- <sup>5</sup> Surface mount processing temperature: 260°C max for 1 minute dwell time. Temperature measured on lead where lead exits molded package.

## **Environmental Ratings:**

Storage Temp: -35°C to \*100°C; Operating Temp: -20°C to \*85°C;

Solder Temp: 270°C max; 10 sec. max

All electrical parameters measured at 25°C unless otherwise specified.

Vibration: 20 G's to 2000 Hz; Shock: 50 G's

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